

S2S5FA0F

V_{DRM} : 600V, Cost effective
Non-zero cross type
Mini-Flat Package
Phototriac Coupler for triggering



■Description

S2S5FA0F Phototriac Coupler include an infrared emitting diode (IRED) optically coupled to an output Phototriac.

These devices feature full wave control and are ideal isolated drivers for medium to high current Triacs.

SOP package provides 3.75kV isolation from input to output with superior commutative noise immunity.

■Features

1. High repetitive peak off-state voltage (V_{DRM} : 600V)
2. Non-zero crossing functionality
3. 4pin Mini-flat package
4. Superior noise immunity
(dV/dt : MIN. 500V/ μ s)
5. Double transfer mold construction
(Ideal for Flow Soldering)
6. High isolation voltage between input and output
($V_{\text{iso(rms)}}$: 3.75kV)

■Agency approvals/Compliance

1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. **S2S5**)
2. Approved by CSA, file No. CA95323 (as model No. **S2S5**)
3. Optionary available VDE Approved^(*)
(DIN EN 60747-5-5), file No. 40009162 (as model No. **S2S5**)
4. Package resin : UL flammability grade (94V-0)

^(*) DIN EN60747-5-5 : successor standard of DIN EN60747-5-2
UP to Date code "S1" (January 2004), approval of DIN EN60747-5-2.
From Date code "E4" (April 2014), approval of DIN EN60747-5-5

■Applications

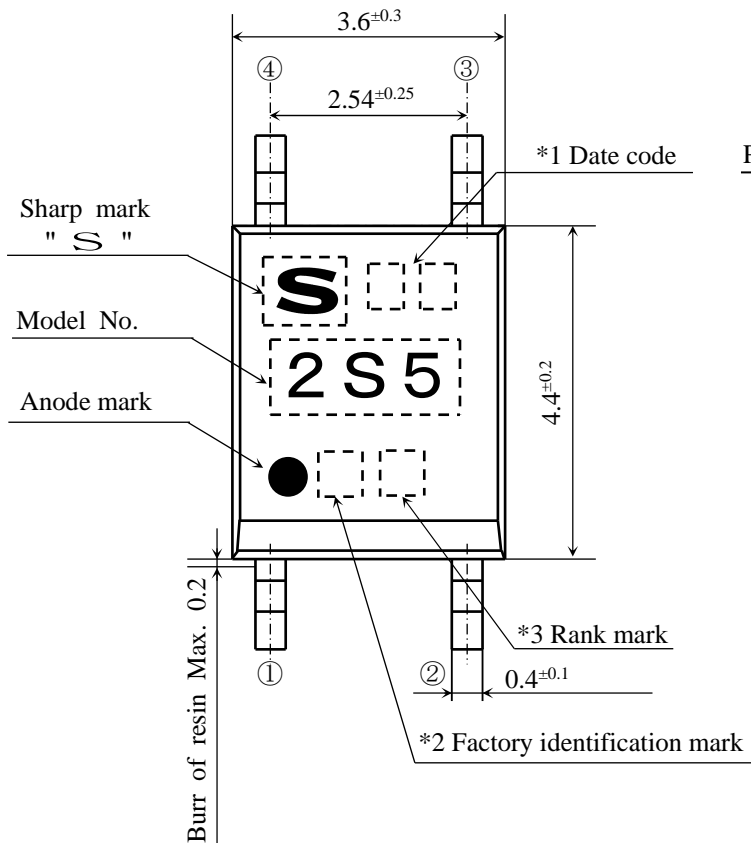
1. Triggering for Triacs used to switch on and off devices which require AC loads.
For example heaters, fans, motors, solenoids, and valves.
2. Triggering for Triacs used for implementing phase control in applications such as lighting control and temperature control (HVAC).
3. AC line control in power supply applications.

Notice The content of data sheet is subject to change without prior notice.

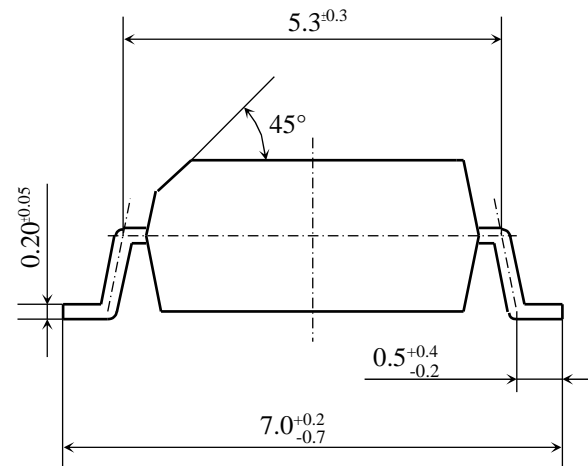
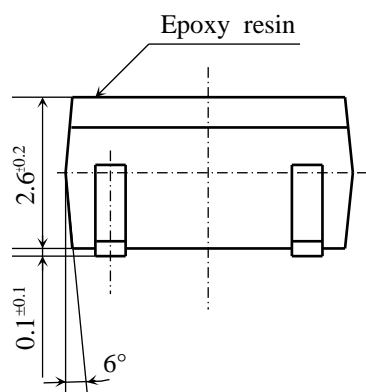
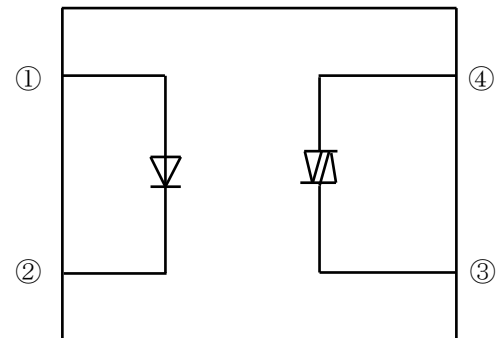
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Sheet No.: OP14019EN

■ Outline



Pin-Number and internal connection diagram



*1 2-digit number shall be marked according to OLD DIN standard.

*2 Factory identification mark applies to the below.

■ or □ : Fujimoto Electric Co., Ltd. Kochi Factory (Japan)
 ▽ : P.T.SHARP SEMICONDUCTOR INDONESIA

*3 Rank mark : F

*4 Marking is laser marking

Pin material : 42Alloy

Pin finish : SnCu plating (Cu : TYP. 2%)

Product mass : Approx. 0.09g

Unit : 1/1mm

Unit : 1/1mm	
Name	S2S5 Outline Dimensions (Business dealing name : S2S5FA0F)

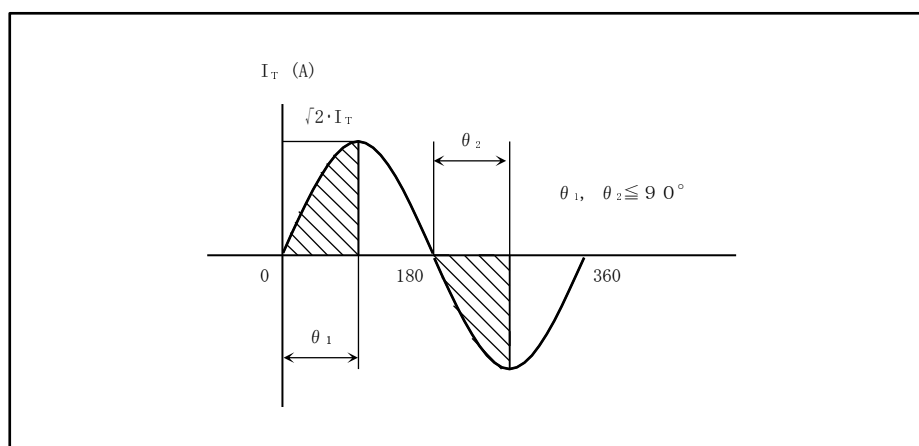
■Absolute maximum ratings

Ta=25°C

Parameter		Symbol	Ratings	Unit
Input	Forward current *1	I_F	50	mA
	Reverse voltage	V_R	6	V
Output	RMS on-state current *1	$I_T(\text{rms})$	0.05	A
	Peak one cycle surge current	I_{surge}	0.6(50Hz sine wave)	A
	Repetitive peak off-state voltage	V_{DRM}	600	V
Isolation voltage *2		$V_{\text{iso}}(\text{rms})$	3.75	kV
Operating temperature		T_{opr}	-30 ~ +100	°C
Storage temperature		T_{stg}	-40 ~ +125	°C
Soldering temperature		T_{sol}	260 (10s)	°C

*1 The derating factors of absolute maximum rating due to ambient temperature are shown in Fig.1,2.

*2 AC for 1min, 40 to 60% RH



■Electrical characteristics

Ta=25°C

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V_F	$I_F=20\text{mA}$	-	1.2	1.4	V
	Reverse current	I_R	$V_R=3\text{V}$	-	-	10	μA
Output	Repetitive peak off-state current	I_{DRM}	$V_D=V_{\text{DRM}}$	-	-	1	μA
	On-state voltage	V_T	$I_T=0.05\text{A}$	-	-	2.5	V
	Holding current	I_H	$V_D=6\text{V}$	0.1	-	3.5	mA
	Critical rate of rise of off-state voltage	dv/dt	$V_D=1/\sqrt{2} \cdot V_{\text{DRM}}$	500	-	-	V/ μs
Transfer characteristics	Minimum trigger current	I_{FT}	$V_D=6\text{V}, R_L=100\Omega$	-	-	10	mA
	Isolation resistance	R_{ISO}	DC500V 40~60% RH	5×10^{10}	10^{11}	-	Ω
	Turn on time	t_{ON}	$V_D=6\text{V}, R_L=100\Omega$ $I_F=20\text{mA}$	-	-	100	μs

Fig.1 Forward current vs. ambient temperature

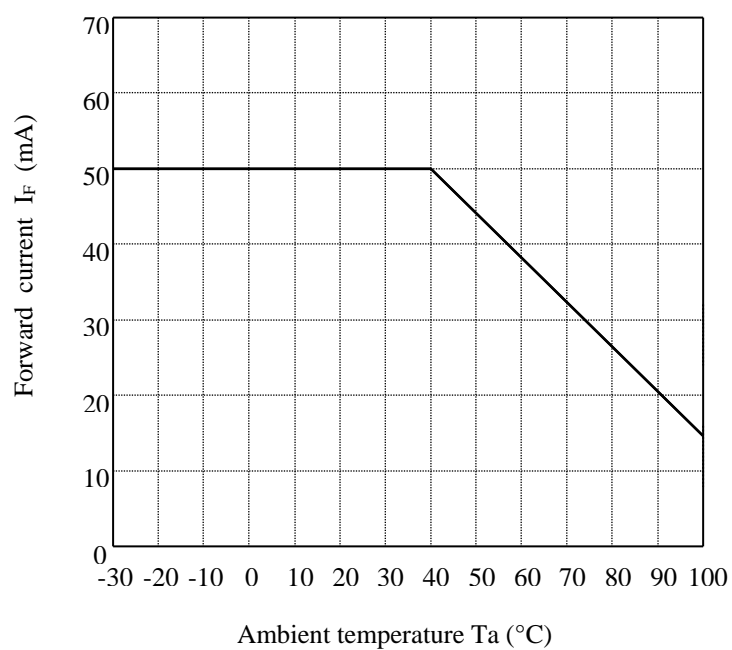
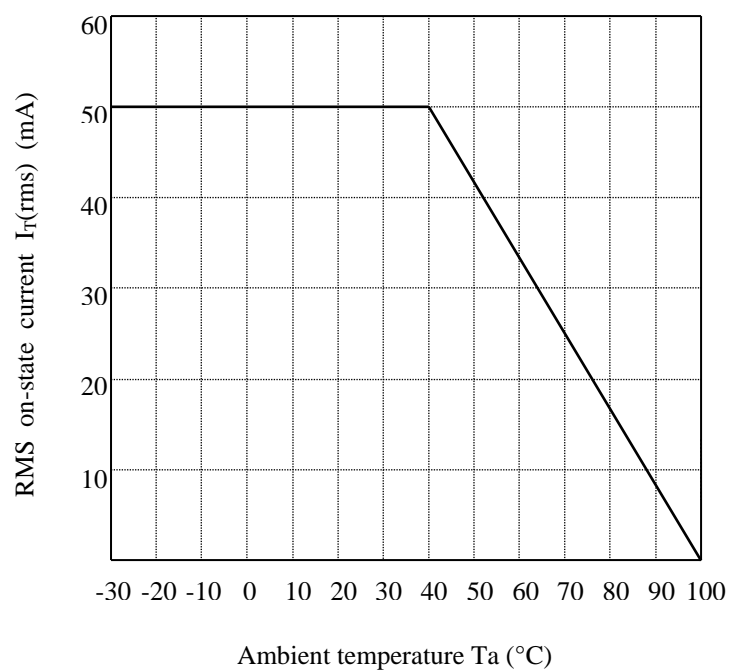



Fig.2 RMS on-state current vs. ambient temperature



■Supplement

- The business dealing name used for this product when ordered or delivered shall be S2S5FA0F.
- Refer to the attached sheet, page 7 to 9.
- Isolation voltage shall be measured in the following method.
 - (1) Short between pins 1 to 2 on the primary side and between pins 3 to 4 on the secondary side.
 - (2) The dielectric withstanding tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.
(It is recommended that the isolation voltage be measured in insulation oil.)
- This Model is approved by UL and CSA
 Approved Model No. : S2S5
 UL File No. : E64380
 CSA File No. : CA95323
 CSA approved mark "  " shall be indicated on minimum unit package.
- This product is not designed against irradiation.
 This product is assembled with electrical input and output.
 This product incorporates non-coherent light emitting diode.
- ODS materials
 - (1) This product shall not contain the following materials.
 - (2) Also, the following materials shall not be used in the production process for this product.
 Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1,1,1-Trichloroethane (Methyl chloroform)
- Specified brominated flame retardants (PBB and PBDE) are not used in this device at all.
- Compliance with each regulation
 - (1) The RoHS directive(2002/95/EC)
 - (2) This product complies with the RoHS directive(2002/95/EC)
 Object substances: mercury, lead (except for lead in high melting temperature type solders*¹ and glass of electronic components), cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)
- Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese : 电子信息产品污染控制管理办法)

Category	Toxic and hazardous substances					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr ⁶⁺)	Polybrominated biphenyls (PBB)	Polybrominated biphenyl ethers (PBDE)
Phototriac coupler	✓	✓	✓	✓	✓	✓

✓ : indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard .

■Notes

- Circuit design

- (1) The LED used in the Phototriac coupler generally decreases the light emission power by operation.
In case of long operation time, please decide I_F value as 2 times or more of the Maximum value of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50%/5years)
- (2) Input current (I_F) at off-state shall be set 0.1mA or less.
- (3) In case that pulse drive is carried out, the pulse width of input signal should be 1ms or more.

- Usage

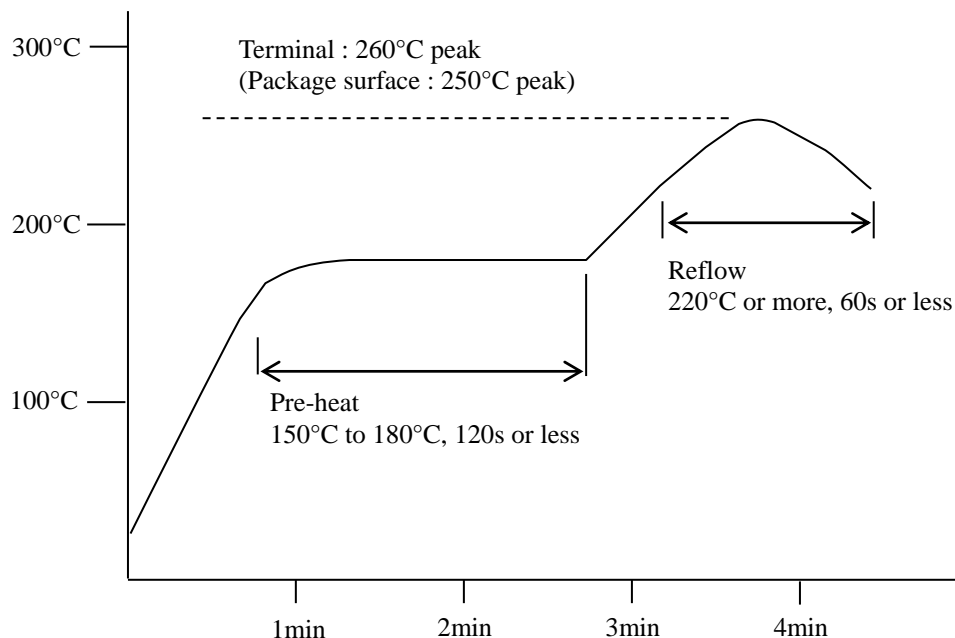
Only for triggering medium power triac and high power triac.
(This model shall be used under the condition on which power triac turns on.)

- Cleaning

- (1) Solvent cleaning : Solvent temperature 45°C or less, Immersion for 3 min or less
- (2) Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc.
Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning.
- (3) Applicable solvents are as follows.
Applicable solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol
When the other solvent is used, there are cases that the packaging resin is eroded.
Please use the other solvent after thorough confirmation is performed in actual using condition.

- Precautions for Soldering Phototriac couplers

- (1) In the case of flow soldering (Whole dipping is possible.)
It is recommended that flow soldering be carried out at 260°C or less and within 10s (Pre-heating : 100 to 150°C, 30 to 80s).
(2 times or less)
- (2) It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)

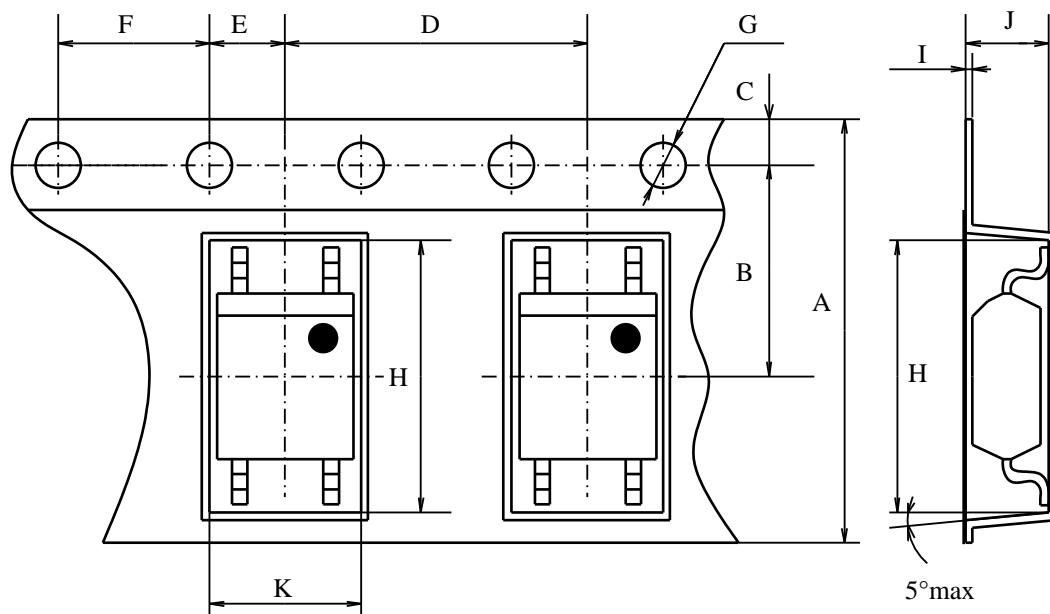


- (3) In the case of hand soldering
It is recommended that hand soldering be carried out at 400°C or less and within 3s : Within 2 times
- (4) Other precautions
Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to junction between PCB and lead pins of photocoupler is different.
Please confirm that there is no problem on the actual use conditions.

■ Package specifications

- Taping conditions
 - (1) Tape structure and Dimensions (Refer to the attached sheet, Page 8)
The carrier tape has the heat pressed structure of A-PET material carries tape and three layers cover tape (PET material base).
 - (2) Reel structure and Dimensions (Refer to the attached sheet, Page 8)
The taping reel shall be of plastic (PS material).
 - (3) Direction of product insertion (Refer to attached sheet, Page 9)
 - (4) The cover tape and carrier tape in one reel shall be joint less.
 - (5) To repair taped failure devices, cutting a bottom of carrier tape with a cutter.
After replacing the cut portion shall be sealed with adhesive tape.
- Adhesiveness of cover tape
The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle 160° to 180°
- Rolling method and quantity
Wind the tape back on the reel so that the cover tape will be outside the tape.
Attach more than 20cm of blank tape to the trailer and the leader of the tape and fix the both ends with adhesive tape. One reel basically shall contain 3,000pcs.
- Outer packing appearance (Refer to attached sheet, Page 9)
- Marking
The label with following information shall be pasted at appointed place of the outer packaging case.
* Model No.* (Business dealing name) * lot No. * quantity * country of origin
* Company name * inspection date specified
- Storage condition
Taped products shall be stored at the temperature 5 to 30°C and the humidity 70%RH or less away from direct sunlight.
- Safety protection during shipping
There shall be no deformation of component or degradation of electrical characteristics due to shipping.

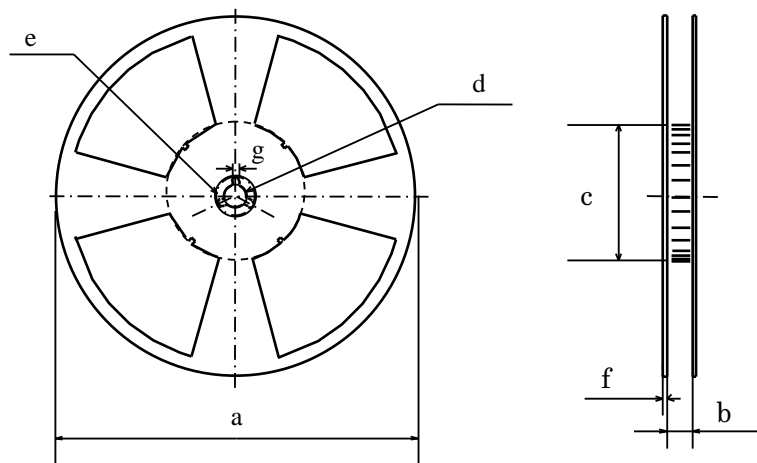
◎ Carrier tape structure and Dimensions



Dimensions list (Unit : mm)

A	B	C	D	E	F	G	H
12.0 ± 0.3	5.50 ± 0.05	1.75 ± 0.10	8.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	φ 1.5 ^{+0.1} ₋₀	7.4 ± 0.1
I	J	K					
0.30 ± 0.05	3.1 ± 0.1	4.0 ± 0.1					

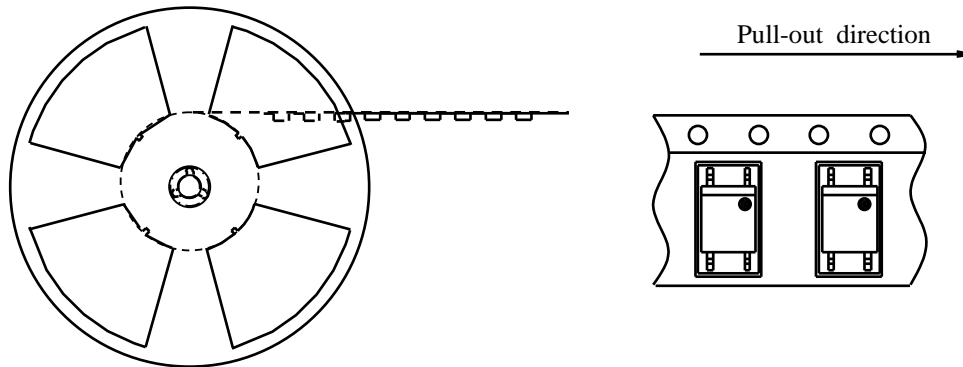
◎ Reel structure and Dimensions



Dimensions list (Unit : mm)

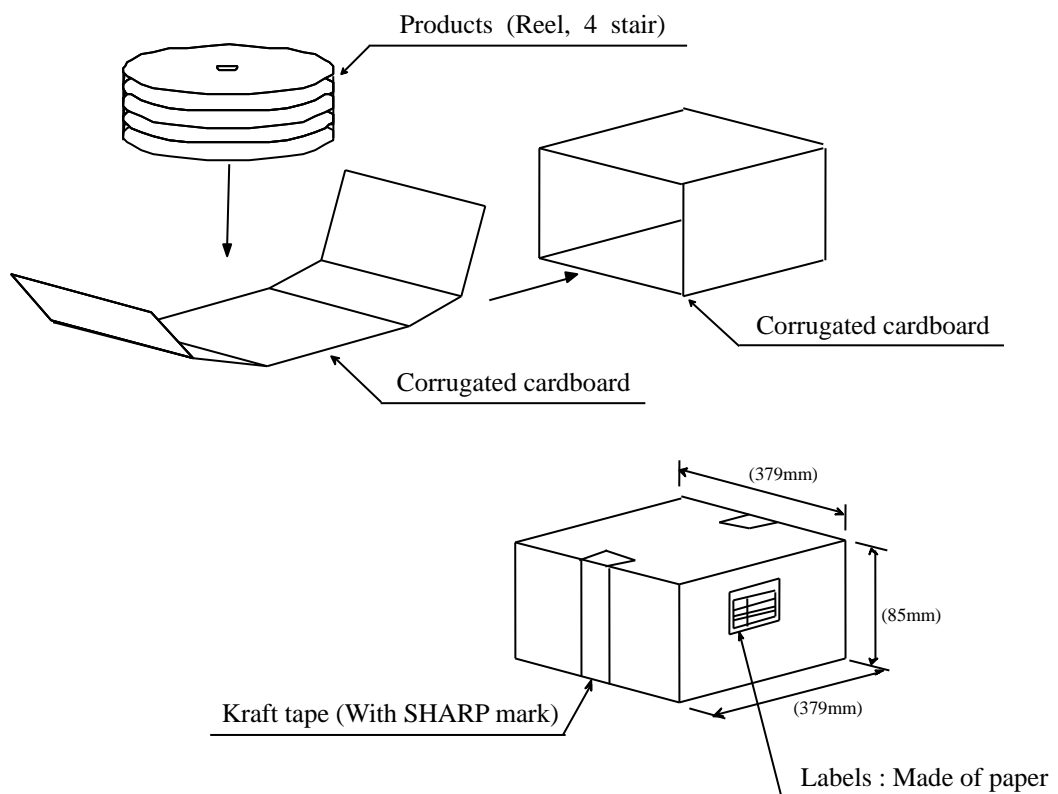
a	b	c	d	e	f	g
(370)	13.5 ± 1.5	φ 100.0 ± 1.0	φ 13.0 ± 0.5	φ 21.0 ± 1.0	2.0 ± 0.5	2.0 ± 0.5

◎ Direction of product insertion



◎ Outer packing appearance

- (1) The entering 3,000 product carrier tape (reel volume) is stored in the outer packaging case.
- (2) The outer packaging case is sealed off with the craft tape, and it sticks labels on.
(four reel or less wrapping 12,000 products or less)



() : Reference dimensions

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- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

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